

# QH05TZ600, QH05BZ600

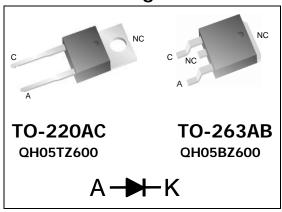
# **Qspeed**<sup>™</sup> Family

600 V, 5 A H-Series PFC Diode

#### **Product Summary**

I <sub>F(AVG)</sub>	5	Α
$V_{RRM}$	600	V
Q <sub>RR</sub> (Typ at 125 °C)	18.9	nC
I <sub>RRM</sub> (Typ at 125 °C)	1.59	Α
Softness t <sub>B</sub> /t <sub>A</sub> (Typ at 125 °C)	0.86	

#### **Pin Assignment**



#### **RoHS Compliant**

Package uses Lead-free plating and Green mold compound. Halogen free per IEC 61249-2-21.

### **General Description**

This device has the lowest  $Q_{RR}$  of any 600 V silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

#### **Applications**

- Power Factor Correction (PFC) boost diode
- Motor drive circuits
- DC-AC inverters

#### **Features**

- Low Q<sub>RR</sub>, low I<sub>RRM</sub>, low t<sub>RR</sub>
- High dI<sub>F</sub>/dt capable (1000 A / μs)
- Soft recovery

#### **Benefits**

- · Increases efficiency
  - Eliminates need for snubber circuits
  - Reduces EMI filter component size & count
- · Enables extremely fast switching

### **Absolute Maximum Ratings**

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Symbol	Parameter	Conditions	Rating	Units
$V_{RRM}$	Peak repetitive reverse voltage	T <sub>J</sub> = 25 °C	600	V
I <sub>F(AVG)</sub>	Average forward current	$T_J = 150  ^{\circ}\text{C},  T_C = 109  ^{\circ}\text{C}$	5	Α
I <sub>FSM</sub>	Non-repetitive peak surge current	60 Hz, ½ cycle, T <sub>C</sub> = 25 °C	50	Α
I <sub>FSM</sub>	Non-repetitive peak surge current	$1/2$ cycle of t = 28 $\mu$ s Sinusoid, $T_C$ = 25 °C	350	Α
TJ	Operating junction temperature range		-55 to 150	°C
$T_{STG}$	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6 mm from case, 10 sec	300	°C
$V_{ISOL}$	Isolation voltage (leads-to-tab)	AC, TO-220	2500	V
V <sub>ISOL</sub>	Isolation voltage (leads-to-tab)	AC, TO-263	1500	V
$P_D$	Power dissipation	$T_C = 25  ^{\circ}C$	36.8	W

www.power.com November 2015

#### **Thermal Resistance**

Symbol	Resistance from:	Conditions	Rating	Units
$R_{\theta JA}$	Junction to ambient	TO-220 (only)	62	°C/W
$R_{ heta JC}$	Junction to case		3.4	°C/W

Electrical Specifications at  $T_1 = 25$  °C (unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
DC Chara	DC Characteristics						
ı	$V_{R} = 600 \text{ V}, T_{J} = 25 \text{ °C}$		С	-	-	250	μΑ
I <sub>R</sub>	Reverse current	$V_R = 600 \text{ V}, T_J = 125$	°C	-	0.31	-	mA
V	Commond valtage	$I_F = 5 \text{ A}, T_J = 25 \text{ °C}$		-	2.6	3.1	V
$V_{F}$	Forward voltage	$I_F = 5 \text{ A}, T_J = 150 \text{ °C}$		-	2.2	-	V
Сл	Junction capacitance	$V_R = 10 \text{ V}, 1 \text{ MHz}$		-	17	-	pF
Dynamic	Characteristics						
	D	dI/dt = 200 A/μs	$T_J = 25$ °C	-	10	-	ns
$t_{RR}$	Reverse recovery time	$V_R = 400 \ V, \ I_F = 5 \ A$	T <sub>J</sub> = 125 °C	-	17.4	-	ns
0		$dI/dt = 200 A/\mu s$	$T_J = 25  ^{\circ}C$	-	6.5	12	nC
$Q_{RR}$	Reverse recovery charge	$V_R = 400 \ V, \ I_F = 5 \ A$	T <sub>J</sub> = 125 °C	-	18.9	-	nC
	Maximum reverse	dI/dt = 200 A/μs	$T_J = 25  ^{\circ}\text{C}$	-	1.0	1.55	Α
I <sub>RRM</sub>	recovery current $V_R = 400 \text{ V}, I_F = 5 \text{ A}$	$V_R = 400 \text{ V}, I_F = 5 \text{ A}$	T <sub>J</sub> = 125 °C	-	1.59	-	Α
	t <sub>B</sub>	dI/dt = 200 A/μs	T <sub>J</sub> = 25 °C	-	0.8	-	
· · · · · · · · · · · · · · · · · · ·	$V_R = 400 \text{ V}, I_F = 5 \text{ A}$	T <sub>J</sub> = 125 °C	-	0.86	-	_	

<u>Note to component engineers</u>: H-Series diodes employ Schottky technologies in their design and construction. Therefore, Component Engineers should plan their test setups to be similar to those for traditional Schottky test setups. (For additional details, see Application Note AN-300.)

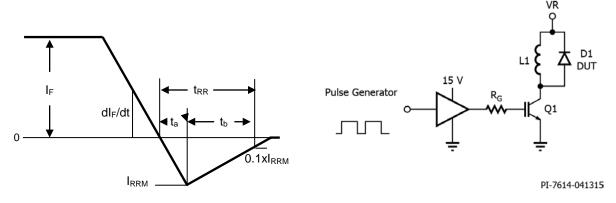
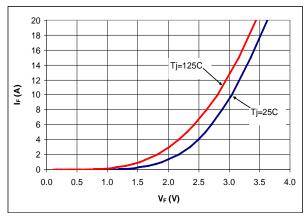


Figure 1. Reverse Recovery Definitions.

Figure 2. Reverse Recovery Test Circuit.

### Electrical Specifications at $T_J = 25$ °C (unless otherwise specified)



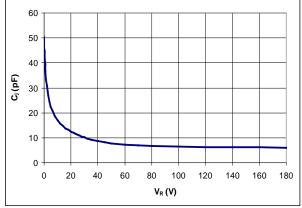
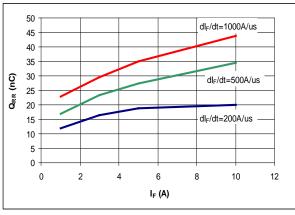


Figure 3. Typical I<sub>F</sub> vs. V<sub>F</sub>.

Figure 4. Typical  $C_J$  vs.  $V_R$ .



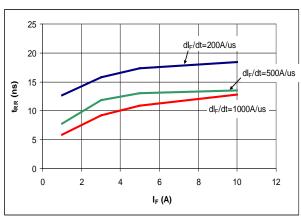
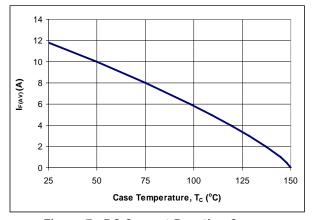


Figure 5. Typical  $Q_{RR}$  vs.  $I_F$  at  $T_J$  = 125 °C.

Figure 6. Typical  $t_{RR}$  vs.  $I_F$  at  $T_J$  = 125 °C.



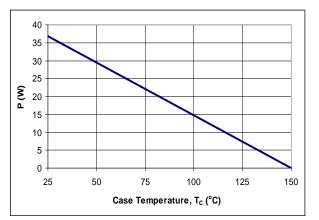


Figure 7. DC Current Derating Curve.

Figure 8. Power Derating Curve.

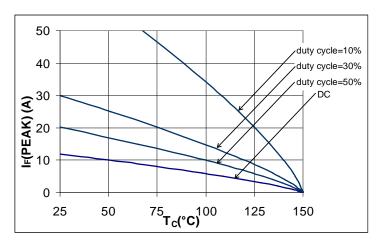


Figure 9.  $I_F$  (PEAK) vs.  $T_C$ , f = 70 kHz.

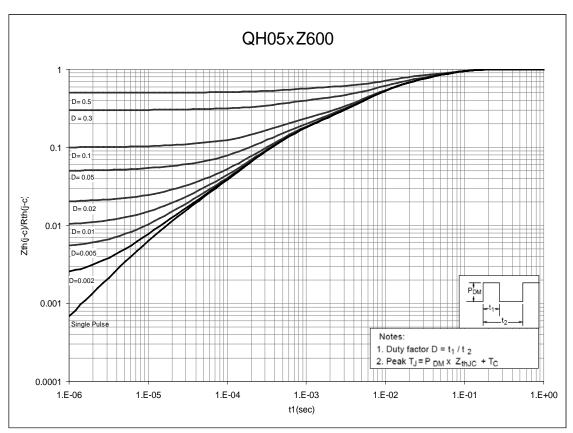
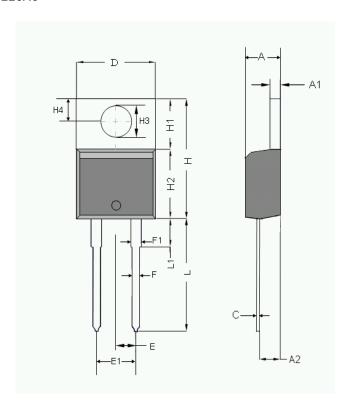


Figure 10. Normalized Maximum Transient Thermal Impedance.

## **Dimensional Outline Drawings**

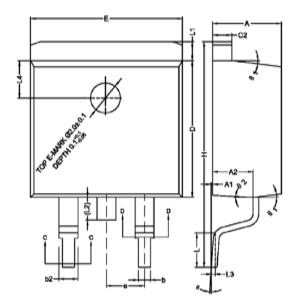
TO-220AC



	Millimeters			
Dim	MIN	MAX		
Α	4.32	4.70		
A1	1.14	1.40		
A2	2.03	2.79		
С	0.34	0.610		
D	9.65	10.67		
E	2.49	2.59		
E1	4.98	5.18		
F	0.508	1.016		
F1	1.14	1.78		
Н	14.71	16.51		
H1	5.84	6.795		
H2	8.40	9.00		
Н3	3.53	3.96		
H4	2.54	3.05		
L	12.70	14.22		
L1	-	6.35		

## **Dimensional Outline Drawings**

TO-263AB

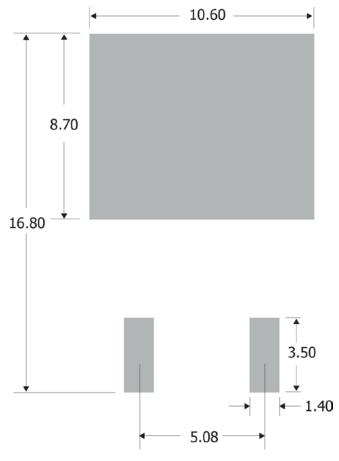


	Millimeters			
Dim	MIN	MAX		
Α	4.40	4.70		
A1	0.00	0.25		
A2	2.59	2.79		
b	0.77	0.90		
b2	1.23	1.36		
c2	1.22	1.32		
D	9.05	9.25		
E	10.06	10.26		
е	2.54 BSC	2.54 BSC		
Н	14.70	15.50		
L	2.00	2.60		
L1	1.17	1.40		
L2	-	1.75		
L3	0.25 BSC	0.25 BSC		
L4	2.00 BSC	2.00 BSC		
Θ	0°	8°		
01	5°	9°		
Θ2	1°	5°		

Mechanical Mounting Method	Maximum Torque / Pressure specification
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm²) or 175 lbf/in²

#### **Footprint and Solder Pad Dimensions**

Pad Dimensions in mm: TO-263AB



**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

### **Ordering Information**

Part Number	Package	Packing
QH05TZ600	TO-220AC	50 units/tube
QH05BZ600	TO-263AB	800 units/reel

The information contained in this document is subject to change without notice.



#### QH05TZ600, QH05BZ600

Revision	Notes	Date
1.0	Released by Ospeed	01/10
1.1	Converted to Power Integrations Document	01/11
1.2	Added QH05BZ600	02/13
1.3	Updated with new Brand Style. Added footprint and solder pad dimension for TO-263AB package.	11/15



#### For the latest updates, visit our website: www.power.com

Power Integrations reserves the right to make changes to its products at any time to improve reliability or manufacturability. Power Integrations does not assume any liability arising from the use of any device or circuit described herein. POWER INTEGRATIONS MAKES NO WARRANTY HEREIN AND SPECIFICALLY DISCLAIMS ALL WARRANTIES INCLUDING, WITHOUT LIMITATION, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF THIRD PARTY RIGHTS.

The products and applications illustrated herein (including transformer construction and circuits' external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at www.power.com. Power Integrations grants its customers a license under certain patent rights as set forth at http://www.power.com/ip.htm.

#### **Life Support Policy**

POWER INTEGRATIONS PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF POWER INTEGRATIONS. As used herein:

- 1. A Life support device or system is one which, (i) is intended for surgical implant into the body, or (ii) supports or sustains life, and (iii) whose failure to perform, when properly used in accordance with instructions for use, can be reasonably expected to result in significant injury or death to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

The PI Logo, TOPSwitch, LinkSwitch, LYTSwitch, InnoSwitch, DPA-Switch, PeakSwitch, CAPZero, SENZero, LinkZero, HiperPFS, HiperTFS, HiperLCS, Ospeed, EcoSmart, Clampless, E-Shield, Filterfuse, FluxLink, StackFET, PI Expert and PI FACTS are trademarks of Power Integrations, Inc. Other trademarks are property of their respective companies. ©Copyright 2015 Power Integrations, Inc.

#### **Power Integrations Worldwide Sales Support Locations**

#### **WORLD HEADQUARTERS**

5245 Hellver Avenue San Jose, CA 95138, USA. Main: +1-408-414-9200 Customer Service: Phone: +1-408-414-9665 Fax: +1-408-414-9765 e-mail: usasales@power.com

**CHINA (SHANGHAI)** 

Rm 2410, Charity Plaza, No. 88, North Caoxi Road, Shanghai, PRC 200030 Phone: +86-21-6354-6323 Fax: +86-21-6354-6325 e-mail: chinasales@power.com

#### **CHINA (SHENZHEN)**

17/F, Hivac Building, No. 2, Keji Nan 8th Road, Nanshan District, Shenzhen, China, 518057 Phone: +86-755-8672-8689 Fax: +86-755-8672-8690 e-mail: chinasales@power.com

#### **GERMANY**

Lindwurmstrasse 114 80337, Munich Germany Phone: +49-895-527-39110

Fax: +49-895-527-39200 e-mail:

eurosales@power.com

#1, 14th Main Road Vasanthanagar Bangalore-560052 India

Phone: +91-80-4113-8020 Fax: +91-80-4113-8023

e-mail:

indiasales@power.com

#### ITALY

Via Milanese 20, 3rd. Fl. 20099 Sesto San Giovanni (MI) Italy

Phone: +39-024-550-8701 Fax: +39-028-928-6009

eurosales@power.com

#### JAPAN

Kosei Dai-3 Building 2-12-11, Shin-Yokohama, Kohoku-ku Yokohama-shi, Kanagawa 222-0033 Japan Phone: +81-45-471-1021 Fax: +81-45-471-3717 e-mail: japansales@power.com

#### **KOREA** RM 602, 6FL

Korea City Air Terminal B/D, 159-6 Samsung-Dong, Kangnam-Gu, Seoul, 135-728 Korea Phone: +82-2-2016-6610 Fax: +82-2-2016-6630

e-mail: koreasales@power.com

#### **SINGAPORE**

51 Newton Road, #19-01/05 Goldhill Plaza Singapore, 308900 Phone: +65-6358-2160 Fax: +65-6358-2015

TAIWAN

5F, No. 318, Nei Hu Rd., Sec. 1 Nei Hu District Taipei 11493, Taiwan R.O.C. Phone: +886-2-2659-4570 Fax: +886-2-2659-4550 e-mail: taiwansales@power.com

Cambridge Semiconductor, a Power Integrations company Westbrook Centre, Block 5, 2nd Floor Milton Road Cambridge CB4 1YG Phone: +44 (0) 1223-446483 e-mail: eurosales@power.com



singaporesales@power.com

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Power Integrations:

QH05TZ600 QH05BZ600